

AN5700-4 February 2021 LN40639

# AN5700 Part Numbering Nomenclature for IGBT & FRD Modules Application Note

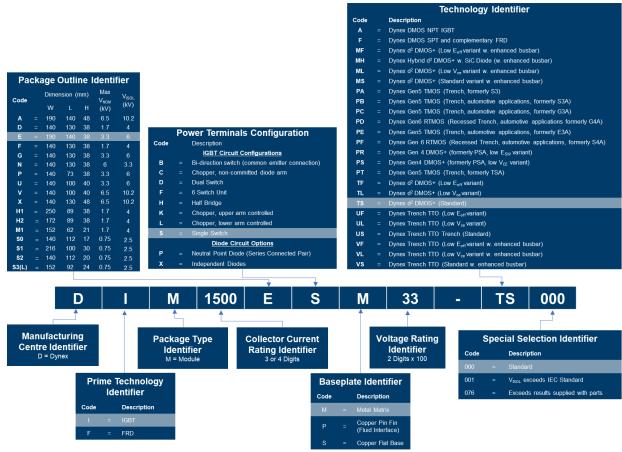
Replaces AN5700-3

# Introduction

Dynex IGBT modules come in a variety of blocking voltages, current capacity, circuit configuration dimensions and isolation voltages; this application note is intended to explain Dynex's module nomenclature regime.



#### AN5700



**IGBT & FRD Module Nomenclature** 

### **Example Model Number**

DIM1000ASM65-US000

# **Manufacturing Centre Identifier**

<b>D</b> IM10	00A	SM65-US000
Code		Description
D	=	Dynex

# **Prime Technology Identifier**

#### DIM1000ASM65-US000

Code Description

I = IGBT

F = FRD

#### Collector Current Rating Identifier DIM1000ASM65-US000

Collector current  $I_c$  ratting may be three or four characters in length; i.e. a 500A module will read as a DIM**500**XSM65-TS000.

# Package Outline Identifier DIM1000<u>A</u>SM65-US000

Code		Di	mensio (mm)	on	<mark>Мах</mark> V <sub>NOM</sub>	
		W	L	Н	(kV)	(kV)
Α	=	190	140	48	6.5	10.2
D	=	140	130	38	1.7	4
Е	=	190	140	38	3.3	6
F	=	140	130	38	1.7	4
G	=	140	130	38	3.3	6
Ν	=	140	130	38	6	3.3
Р	=	140	73	38	3.3	6
U	=	140	100	40	3.3	6
V	=	140	100	40	6.5	10.2
Х	=	140	130	48	6.5	10.2
H1	=	250	89	38	1.7	4
H2	=	172	89	38	1.7	4
M1	=	152	62	21	1.7	4
S0	=	140	112	17	0.75	2.5
S1	=	216	100	30	0.75	2.5
S2	=	140	112	20	0.75	2.5
S3*	=	152	92	24	0.75	2.5

\*Standard tab option use special selection 500, for Long tab option use special selection 502

# **Power Terminals Configuration Identifier**

DIM1000ASM65-US000

Modules may be configured in the following options:

#### **IGBT Circuit Configuration**

Code		Configuration
В	=	Bi-direction switch (common emitter connection)
D	=	Dual Switch
С	=	Chopper, non-committed diode arm
F	=	6 Switch Unit
K	=	Chopper, upper arm controlled
L	=	Chopper, lower arm controlled
S	=	Single Switch
Н	=	Half Bridge
		Diode Circuit Configuration
Р	=	Neutral Point Diode (Series Connected Pair)
Х	=	Independent Diodes

#### **Baseplate Material Identifier** DIM1000ASM65-US000

Letter	Baseplate Material

Ρ Copper Pin Fin Base (Fluid interface) =

S **Copper Flat Base** =

# **Voltage Rating Identifier**

DIM1000ASM65-US000

Multiply two-digit voltage rating identifier by 100.

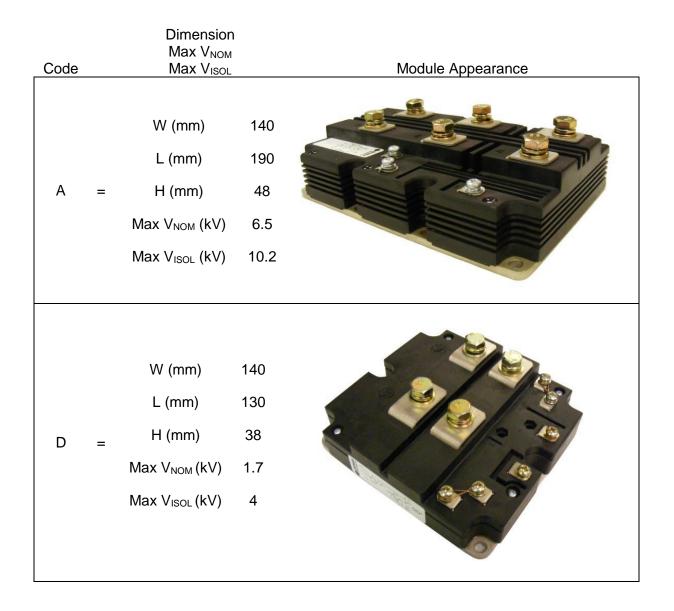
# **Technology Identifier**

DIM1000ASM65-US000

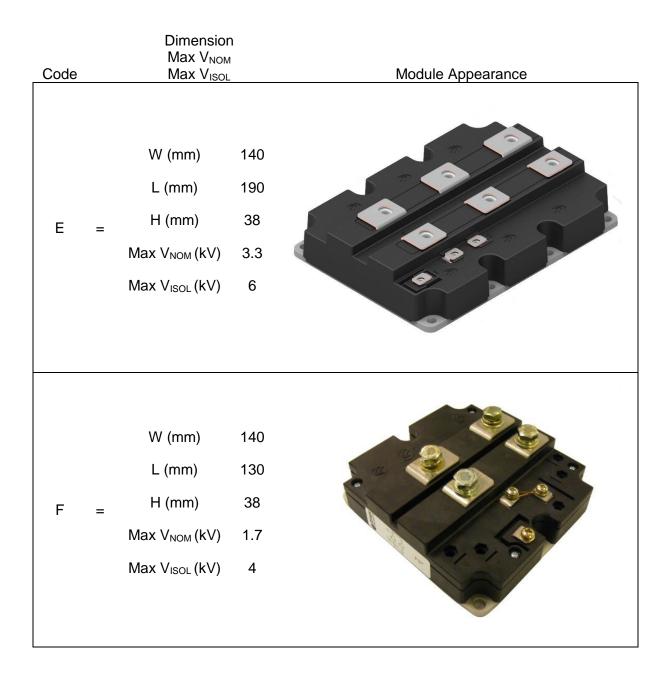
Code		Description
А	=	Dynex DMOS NPT IGBT
F	=	Dynex DMOS SPT and complementary FRD
MF	=	Dynex d <sup>2</sup> DMOS+ (Low E <sub>off</sub> variant w. enhanced busbar)
MH	=	Dynex Hybrid d <sup>2</sup> DMOS+ w. SiC Diode (w. enhanced busbar)
ML	=	Dynex d <sup>2</sup> DMOS+ (Low $V_{ce}$ variant w. enhanced busbar)
MS	=	Dynex d <sup>2</sup> DMOS+ (Standard variant w. enhanced busbar)
PA	=	Dynex Gen5 TMOS (Trench, formerly S3)
PB	=	Dynex Gen5 TMOS (Trench, automotive applications, formerly S3A)
PC	=	Dynex Gen5 TMOS (Trench, automotive applications, formerly G3A)
PD	=	Dynex Gen6 RTMOS (Recessed Trench, automotive applications formerly G4A)
PE	=	Dynex Gen5 TMOS (Trench, automotive applications, formerly E3A)
PF	=	Dynex Gen 6 RTMOS (Trench, automotive applications, formerly S4A)
PR	=	Dynex Gen4 DMOS+ (formerly PSA012, low E <sub>SW</sub> variant)
PS	=	Dynex Gen4 DMOS+ (formerly PSA011 low V <sub>CE</sub> variant)
PT	=	Dynex Gen5 TMOS (Trench, formerly TSA)
TF	=	Dynex d <sup>2</sup> DMOS+ (Low E <sub>off</sub> variant)
TL	=	Dynex d <sup>2</sup> DMOS+ (Low V <sub>ce</sub> variant)
TS	=	Dynex d <sup>2</sup> DMOS+ (Standard)
UF	=	Dynex Trench TSPT (Low E <sub>off</sub> variant)
UL	=	Dynex Trench TSPT (Low V <sub>ce</sub> variant)
US	=	Dynex Trench TSPT Trench (Standard)
VF	=	Dynex Trench TSPT (Low E <sub>off</sub> variant w. enhanced busbar)
VL	=	Dynex Trench TSPT (Low V <sub>ce</sub> variant w. enhanced busbar)
VS	=	Dynex Trench TSPT (Standard w. enhanced busbar)

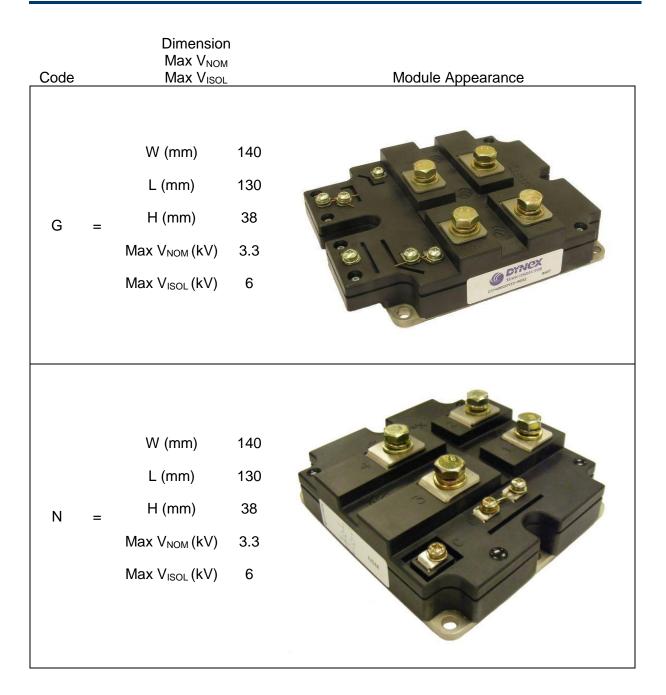
# Special Selection Identifier DIM1000ASM65-US000

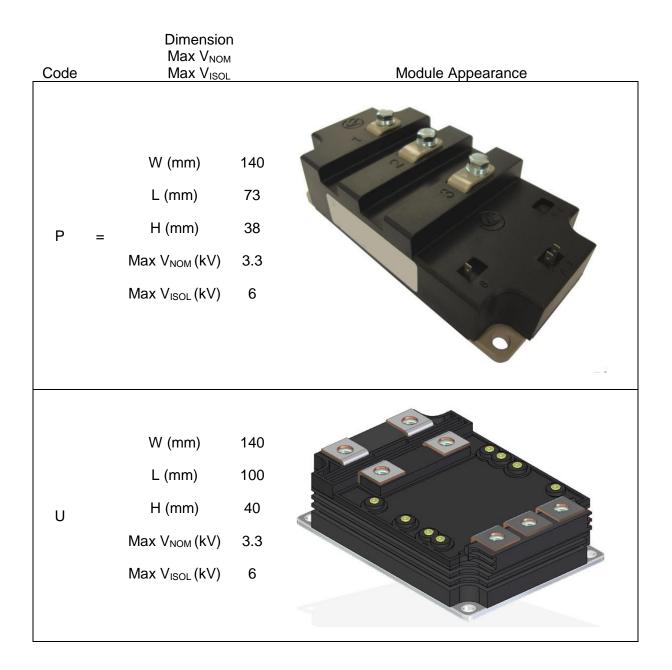
Code		Description
000	=	Standard Product
001	=	Isolation voltage exceeds IEC standard for blocking voltage
076	=	Electrical result supplied with module.
XXX	=	Special Selection

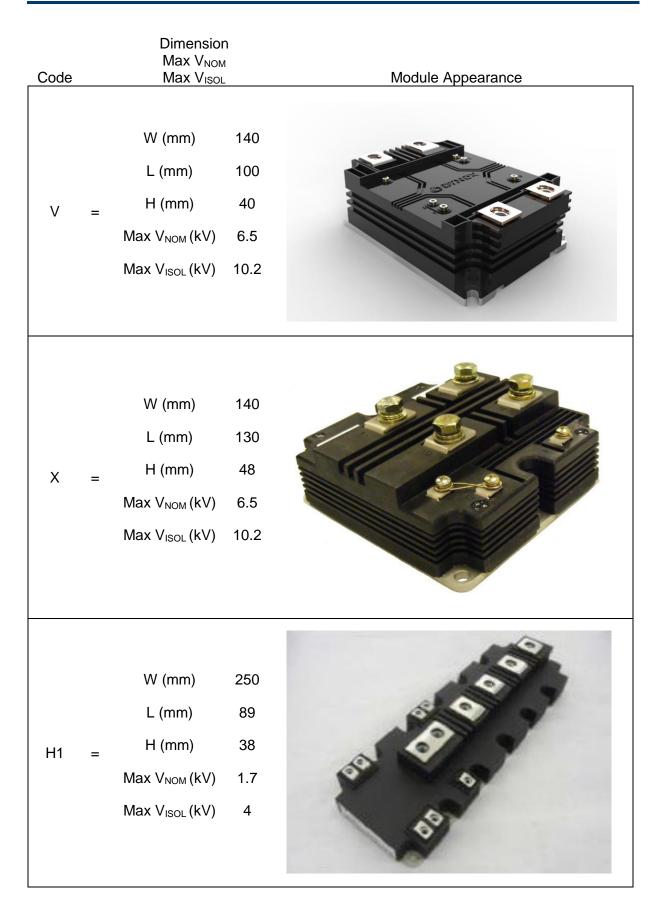


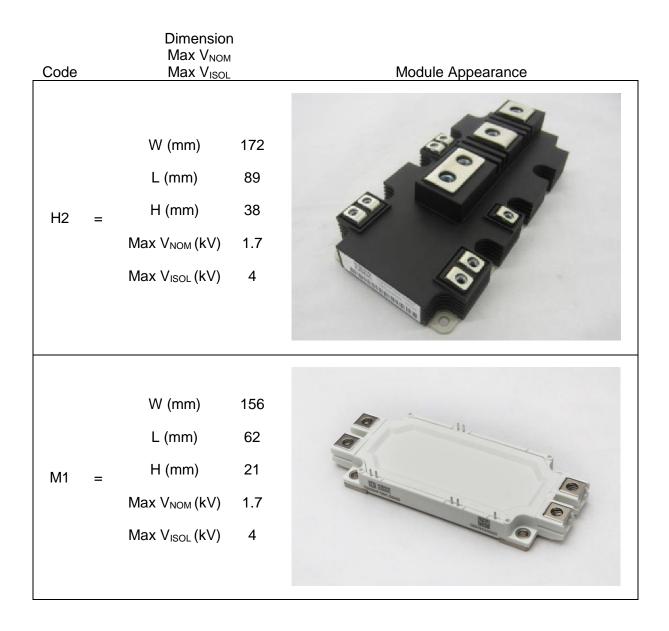
# **Annex 1: Package Outline Detailed Description**



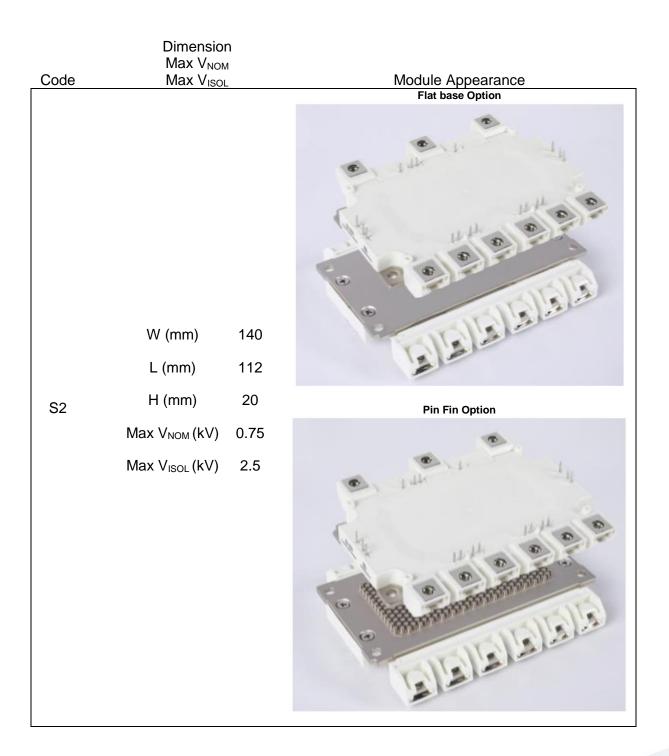


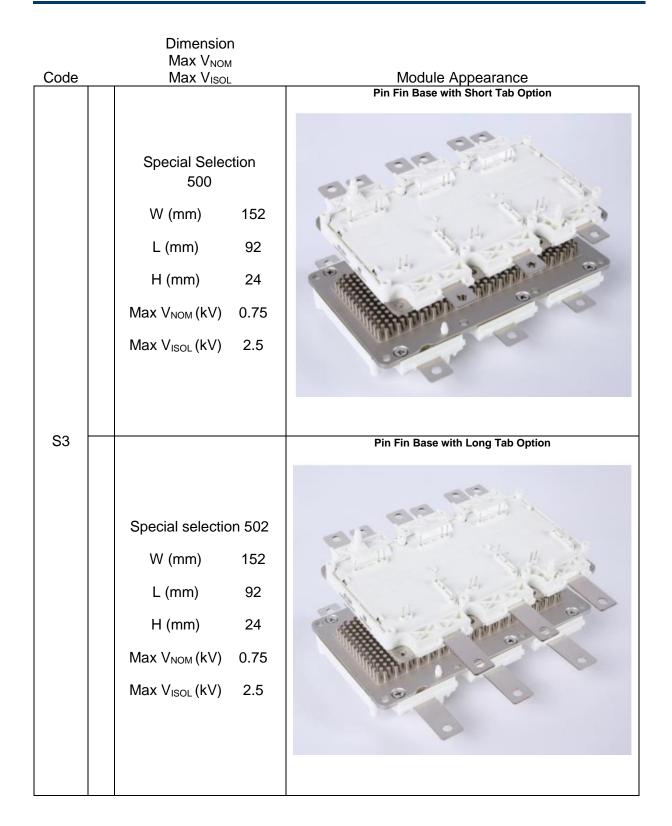






Code	Dimension Max V <sub>NOM</sub> Max V <sub>ISOL</sub>		Module Appearance
S0 =	W (mm) L (mm) H (mm) Max V <sub>NOM</sub> (kV) Max V <sub>ISOL</sub> (kV)	140 112 17 0.75 2.5	



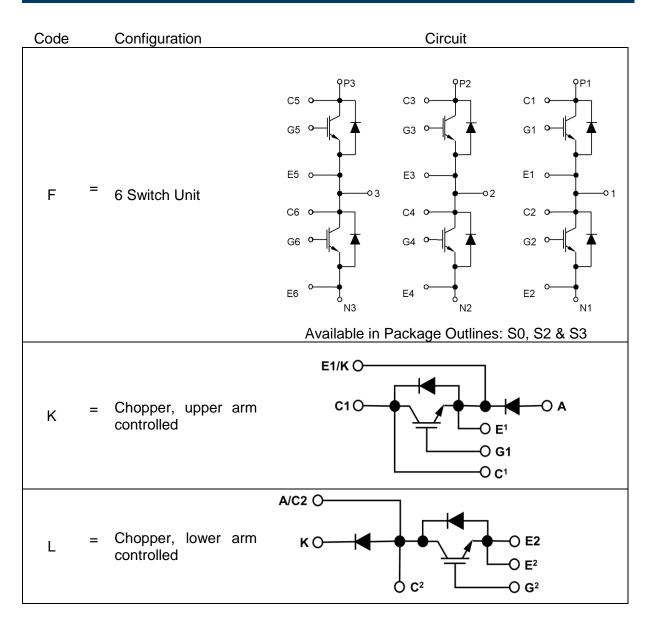


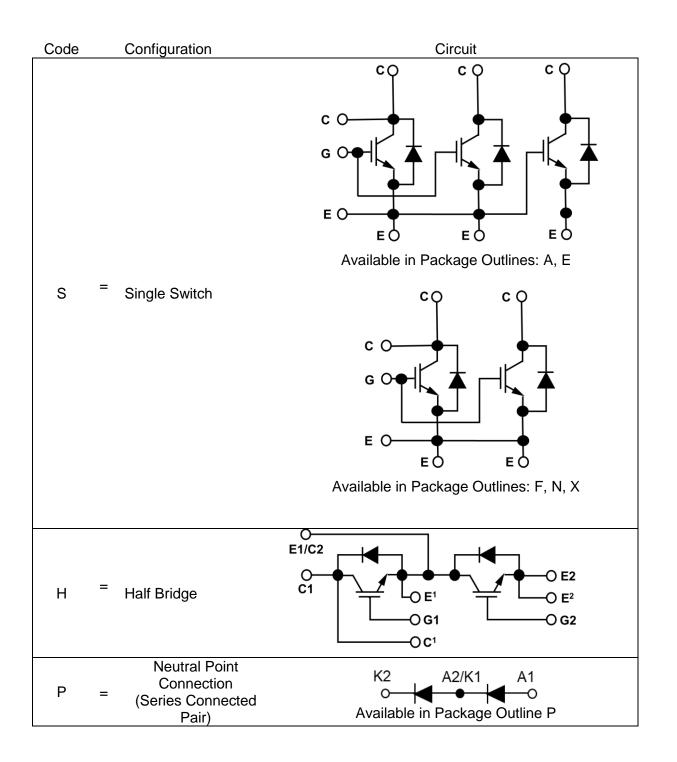
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Annex 2: Circuit Configuration Note: Terminal identifiers may change dependent on selected package, refer to individual datasheet for correct terminal alias.

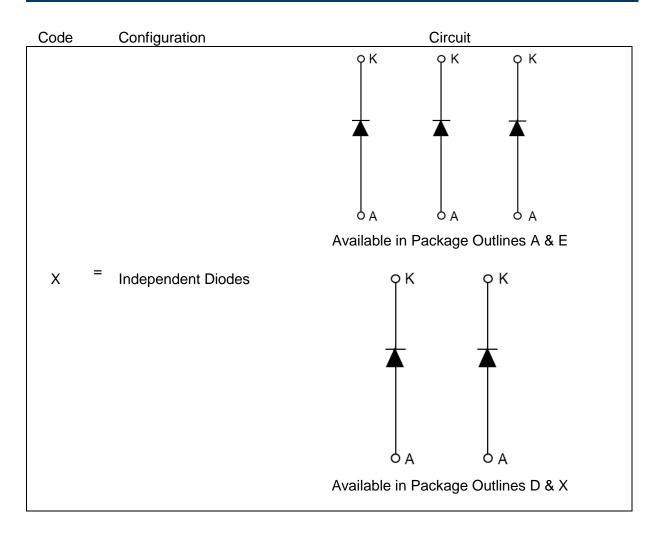
Code		Configuration	Circuit
В	=	Bi-directional switch	$E1/E2$ $C1 \qquad 0 \qquad $
D	=	Dual Switch	$E^{1} \qquad \bigcirc C^{2} \qquad \bigcirc C^{2$
С	=	Chopper non-committed diode arm	$\begin{array}{c c} & & & & & & \\ & & & & & \\ & & & & \\ & & & & \\ & & & \\ & & & \\ \hline \\ & & & \\ & & \\ \hline \\ & & \\ & & \\ & & \\ & & \\ \hline \\ & & \\ & \\$

#### AN5700





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